Product Preview

Low Current LED Driver

This device is designed to replace discrete solutions for driving LEDs in AC/DC applications. An external resistor allows the circuit designer to set the drive current for different LED arrays. This discrete integration technology eliminates individual components by combining them into a single package, which results in a significant reduction of both system cost & board space. The device is a small surface mount package (SO–8).

Features

- Supplies Constant LED Current for Varying Input Voltages.
- External Resistor Allows Designer to Set Current up to 100 mA.
- Offered in Surface Mount Package Technology (SO-8).

Benefits

- Maintains a Constant Light Output During Battery Drain.
- One Device Can Be Used for Many Different LED Products.
- Reduces Board Space & Component Count.
- Simplifies Circuit and System Designs.

Typical Applications

- Portables: For Battery Back-up Applications, also Simple Ni-CAD Battery Charging.
- Industrial: General Lighting Applications and Small Appliances.
- Automotive: Tail Lights, Directional Lights, Back-up Light, Dome Light.

PIN FUNCTION DESCRIPTIONS

Pin	Symbol	Description		
1	V _{in}	Positive input voltage to the device		
2	N/C	No connection		
3	R _{ext}	An external resistor between R_{ext} and V_{in} pins sets different current levels for different application needs		
4	GND	Ground		
5, 6, 7, 8	I _{out}	The LEDs are connected from these pins to ground		

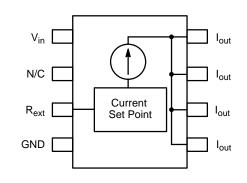
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PIN CONFIGURATION AND SCHEMATIC





SO-8 CASE 751

MARKING DIAGRAM



4011 = Specific Device Code A = Assembly Location

Y = Year W = Work Week

ORDERING INFORMATION

Device	Package	Shipping [†]		
NUD4011DR2	SO-8	2500 / Tape & Reel		

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

MAXIMUM RATINGS ($T_J = 25^{\circ}C$ unless otherwise noted)

Rating	Symbol	Value	Unit
Input Voltage	V _{in}	200	V
Output Current (For $V_{drop} \le 12 \text{ V}$), (Note 1)	l _{out}	100	mA
Output Voltage	V _{out}	198	V
Human Body Model (HBM)	ESD	2000	V

 $[\]frac{}{1. \text{ V}_{drop} = \text{V}_{in} - 0.7 \text{ V} - \text{V}_{LEDs}}$

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Operating Ambient Temperature	T _A	-40 to +125	°C
Maximum Junction Temperature	TJ	150	°C
Storage Temperature	T _{STG}	-55 to +150	°C
Total Power Dissipation (Note 2) Derating above 25°C (Fig. 3)	P _D	1.25 10	W mW/°C
Thermal Resistance Junction-to-Ambient (Note 2)	$R_{ hetaJA}$	100	°C/W

^{2.} Mounted onto FR-4, 1" pad, 1 oz coverage.

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Output Current1 (V_{in} = 12 V, R_{ext} = 7.0 Ω , V_{LEDs} = 7.0 V)	I _{out1}	_	100	-	mA
Output Current2 (V_{in} = 200 V, R_{ext} = 140 Ω , V_{LEDs} = 7.0 V)	I _{out2}	_	5.0	-	mA
Bias Current (V _{in} = 12 V, R _{ext} = Open, V _{LEDs} = 7.0 V)	I _{Bias}	_	0.5	-	mA
Voltage Overhead (Note 3)	V _{over}	1.4	_	=	V

^{3.} $V_{over} = V_{in} - V_{LEDs}$

TYPICAL PERFORMANCE CURVES

(T_J = 25°C unless otherwise noted)

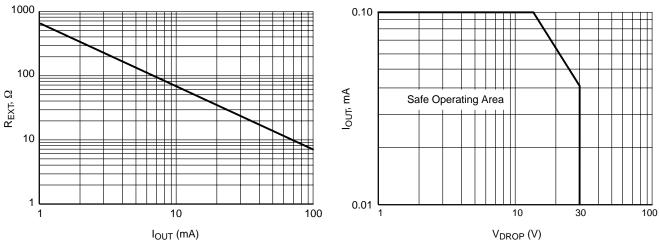


Figure 1. Output Current (I_{OUT}) vs. External Resistor (R_{EXT})

Figure 2. Voltage Across Driver (V_{DROP}) vs. Output Current (I_{OUT})

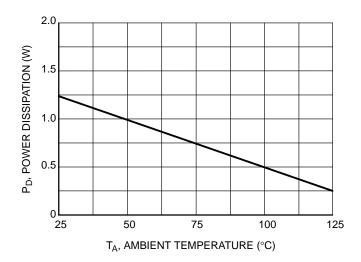


Figure 3. Max Power Dissipation (PD) vs. Ambient Temperature (TA)

APPLICATION INFORMATION

Design Guide

- 1. Determine I_{out} LED's current:
 - a. $I_{LED} = 100 \text{ mA}$
- 2. Calculate Resistor Value for Rext:
 - a. $R_{ext} = 0.7 \text{ V} / I_{out}$
 - b. $R_{ext} = 0.7/0.100 = 7$ ohms
- 3. Define V_{in}:
 - a. Per Example in Fig 4, $V_{in} = 12 \text{ V}$
- 4. Define V_{LED} @ I_{LED} per LED supplier's data sheet:
 - b. Per Example in Fig. 4,

$$V_{LED} = 3.5 V + 3.5 V + 3.5 V = 10.5 V$$

- 5. Calculate V_{drop} across NUD4011:
 - a. $V_{drop} = Vin 0.7V VLED$
 - b. $V_{drop} = 12.0 \text{ V} 0.7 \text{ V} 10.5 \text{ V}$
 - c. $V_{drop} = 0.8 \text{ V}$
- 6. Calculate Power Dissipation (P_D):

 - a. $P_D = V_{drop} * I_{out}$ b. $P_D = 0.8 \ V * 0.100 \ A$
 - c. $P_D = 80 \text{ mW}$
- 7. If $P_D > 1.25 \text{ W}$ (or derated value based on ambient temperature, Fig. 3), then select the most appropriate recourse and repeat steps 1-6:
 - a. Reduce V_{in}
 - b. Reconfigure LED array to reduce V_{drop}
 - c. Reduce I_{out} by increasing R_{ext}

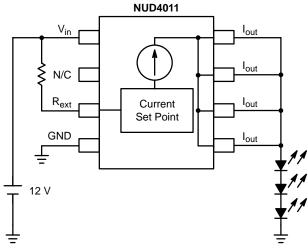
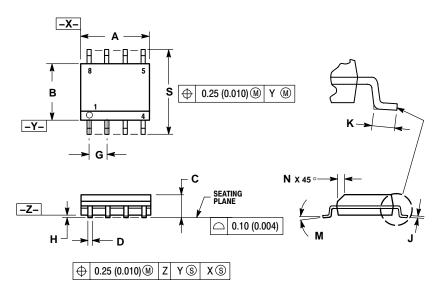


Figure 4. 12 V Application (Series LED's Array)

PACKAGE DIMENSIONS

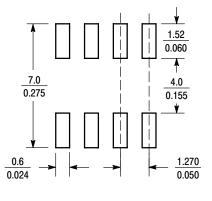
SO-8 CASE 751-07 **ISSUE AA**



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE
- 4. MAXIMUM MOLD PHO HUSION 0.15 (0.006) PER SIDE.
 5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
 6. 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	4.80	5.00	0.189	0.197	
В	3.80	4.00	0.150	0.157	
С	1.35	1.75	0.053	0.069	
D	0.33	0.51	0.013	0.020	
G	1.27	BSC	0.050 BSC		
Н	0.10	0.25	0.004	0.010	
J	0.19	0.25	0.007	0.010	
K	0.40	1.27	0.016	0.050	
M	0 °	8 °	0 °	8 °	
N	0.25	0.50	0.010	0.020	
S	5.80	6.20	0.228	0.244	

SOLDERING FOOTPRINT*



 $\left(\frac{\text{mm}}{\text{inches}}\right)$

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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